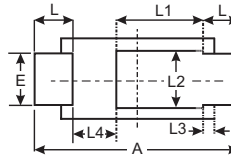
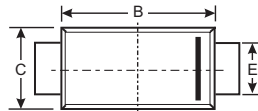
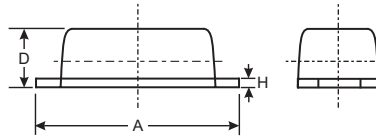


### Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Low Forward Voltage Drop and High Current Capability
- **Lead Free Finish, RoHS Compliant (Note 2)**
- "Green" Molding Compound (No Br, Sb)
- **Qualified to AEC-Q101 Standards for High Reliability**



PowerDI™123			
Dim	Min	Max	Typ
A	3.50	3.90	3.70
B	2.60	3.00	2.80
C	1.63	1.93	1.78
D	0.93	1.00	0.98
E	0.85	1.25	1.00
H	0.15	0.25	0.20
L	0.45	0.85	0.65
L1	—	—	1.35
L2	—	—	1.10
L3	—	—	0.20
L4	0.90	1.30	1.05
All Dimensions in mm			

### Mechanical Data

- Case: PowerDI™ 123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: Cathode Band
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Marking & Type Code Information: See Last Page
- Ordering Information: See Last Page
- Weight: 0.01 grams (approximate)

### Maximum Ratings and Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise specified

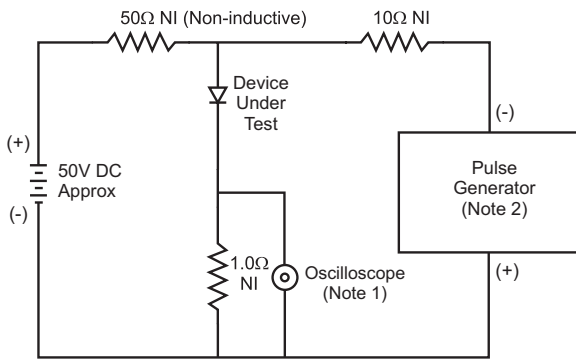
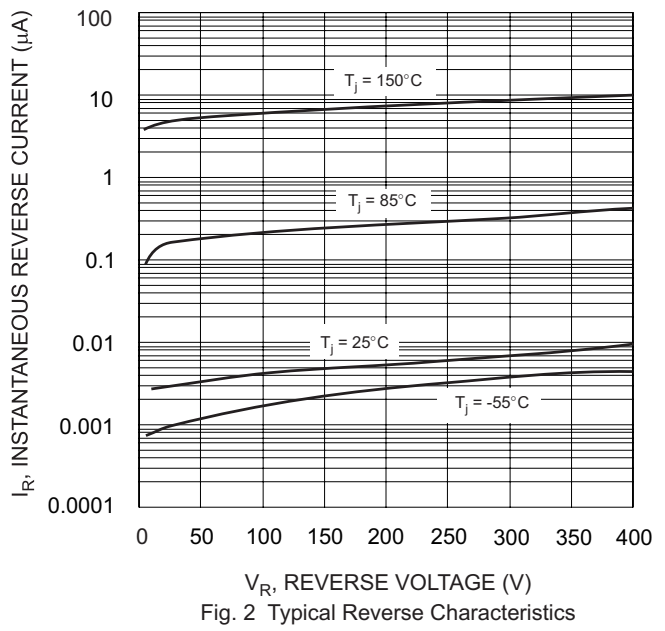
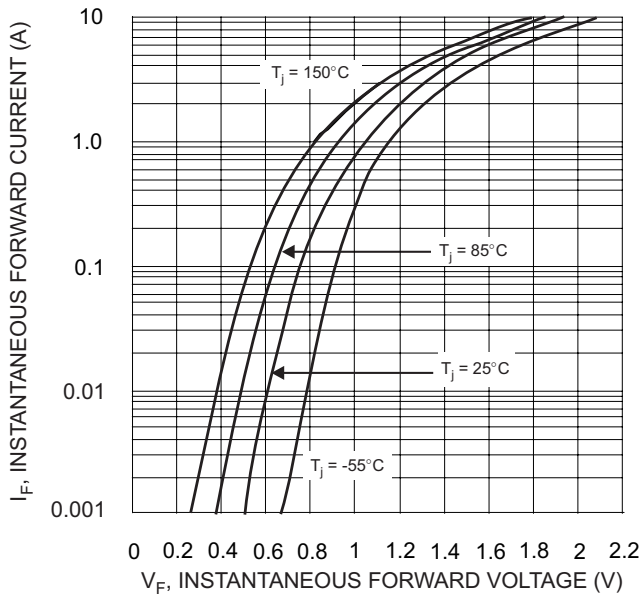
Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	DFLU1400	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	400	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	280	V
Average Rectified Output Current	I <sub>O</sub>	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I <sub>FSM</sub>	30	A
Forward Voltage Drop (Note 5) @ I <sub>F</sub> = 1.0A	V <sub>FM</sub>	1.25	V
Peak Reverse Current @ T <sub>A</sub> = 25°C at Rated DC Blocking Voltage (Note 5) @ T <sub>A</sub> = 100°C	I <sub>RM</sub>	5.0 200	μA
Reverse Recovery Time (Note 4)	t <sub>rr</sub>	25	ns
Typical Total Capacitance (f = 1MHz, V <sub>R</sub> = 4VDC)	C <sub>T</sub>	14	pF
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +150	°C

### Thermal Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Typ	Max	Unit
Power Dissipation (Note 1)	P <sub>D</sub>	—	1.0	W
Thermal Resistance Junction to Ambient (Note 1)	R <sub>θJA</sub>	117	—	°C/W
Thermal Resistance Junction to Soldering (Note 3)	R <sub>θJS</sub>	—	6	°C/W

- Notes:
1. Device mounted on 1" x 1", Polyimide PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document AP02001.pdf.
  2. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7*.
  3. Theoretical R<sub>θJS</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
  4. Measured with I<sub>F</sub> = 0.5A, I<sub>R</sub> = 1.0A, I<sub>rr</sub> = 0.25A. See figure 5.
  5. Short duration pulse test to minimize self-heating effect.



Notes:  
 1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.  
 2. Rise Time = 10ns max. Input Impedance = 50Ω.

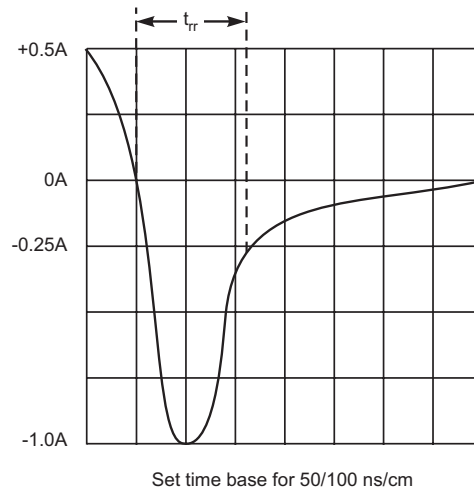
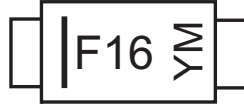


Fig. 3 Reverse Recovery Time Characteristic and Test Circuit

**Ordering Information** (Note 6)

Device	Marking Code	Packaging	Shipping
DFLU1400-7	F16	PowerDI™123	3000/Tape & Reel

Notes: 6. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**


F16 = Product Type Marking Code (See Table Above)  
 YM = Date Code Marking  
 Y = Year (ex: S = 2005)  
 M = Month (ex: 9 = September)

## Date Code Key

Year	2005	2006	2007	2008	2009
Code	S	T	U	V	W

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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